

Test Laboratory: Compliance Certification Services
 File Name: [RC1 - SO3 8k Enhanced Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

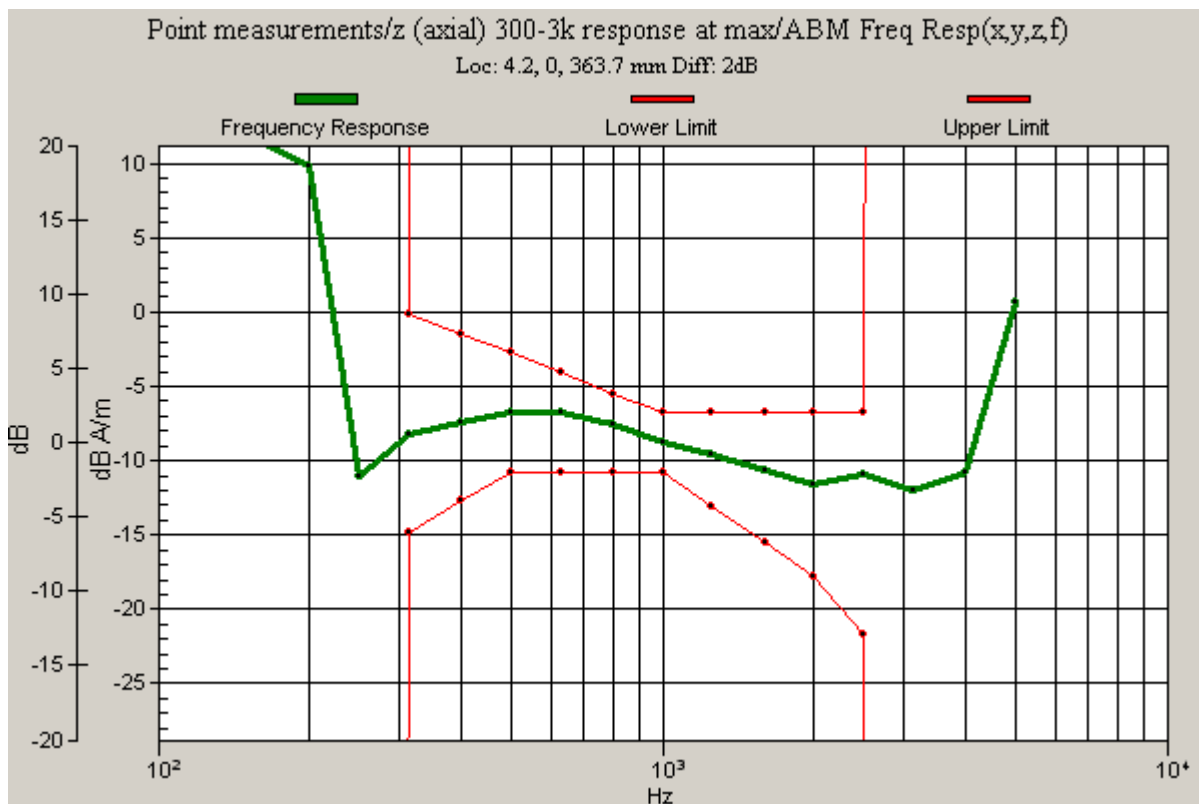
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: 4.2, 0, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC2 - SO17 13k Low - Ch 1013.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 824.7 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

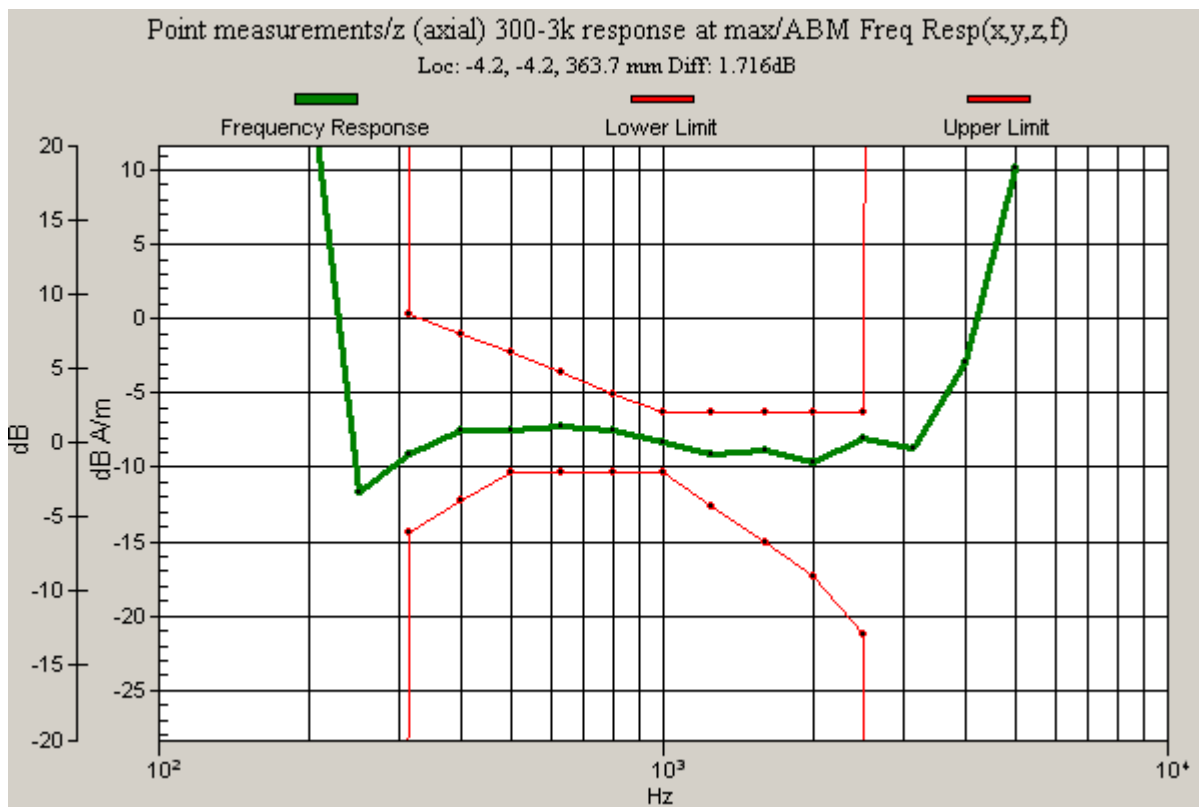
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 1.7159 dB

BWC Factor = 10.8 dB

Location: -4.2, -4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC2 - SO17 13k Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

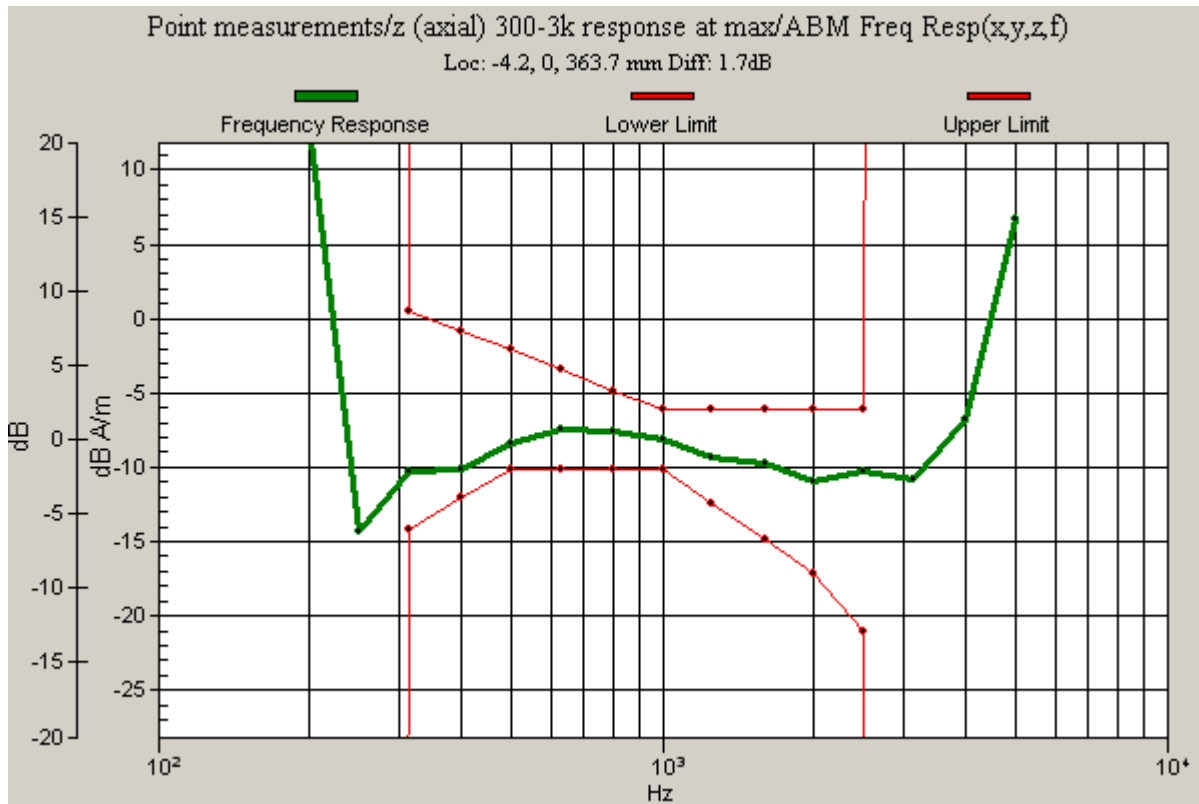
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 1.69978 dB

BWC Factor = 10.8 dB

Location: -4.2, 0, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC2 - SO17 13k Low - Ch 777.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 848.31 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

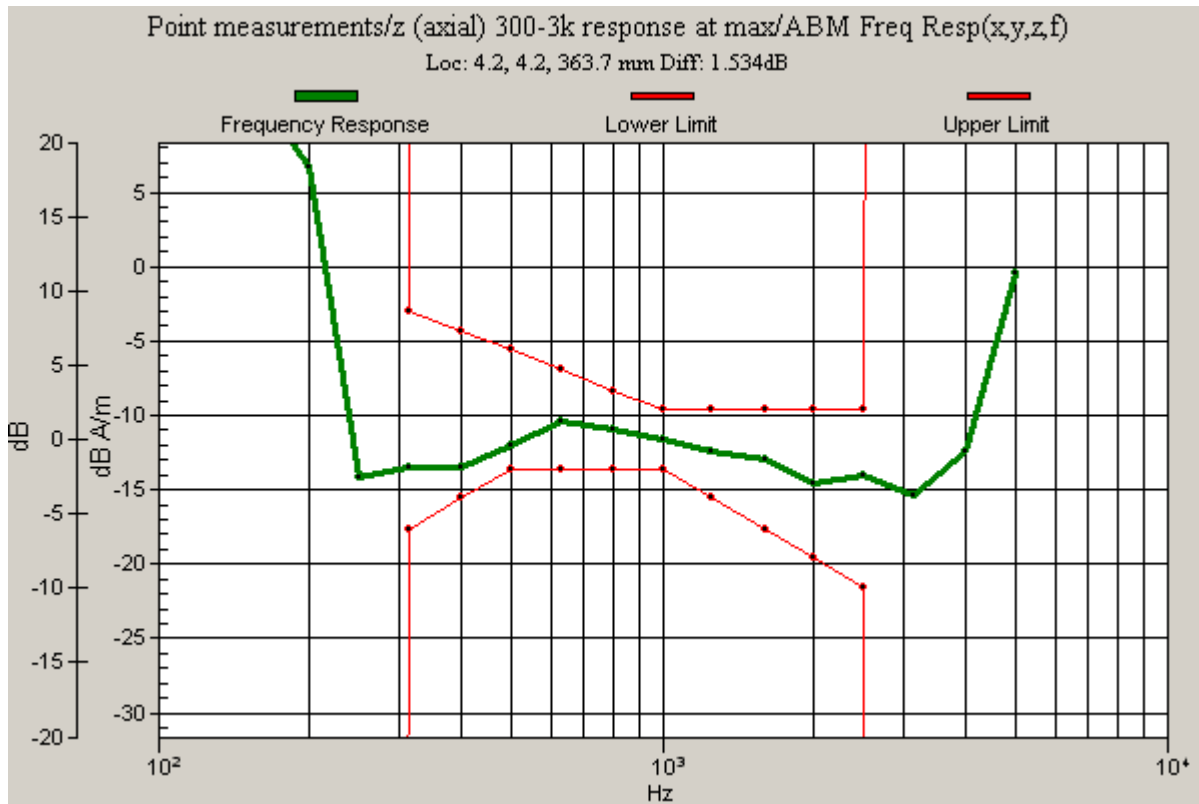
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 1.53438 dB

BWC Factor = 10.8 dB

Location: 4.2, 4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC3 - SO3 8k Enhanced Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

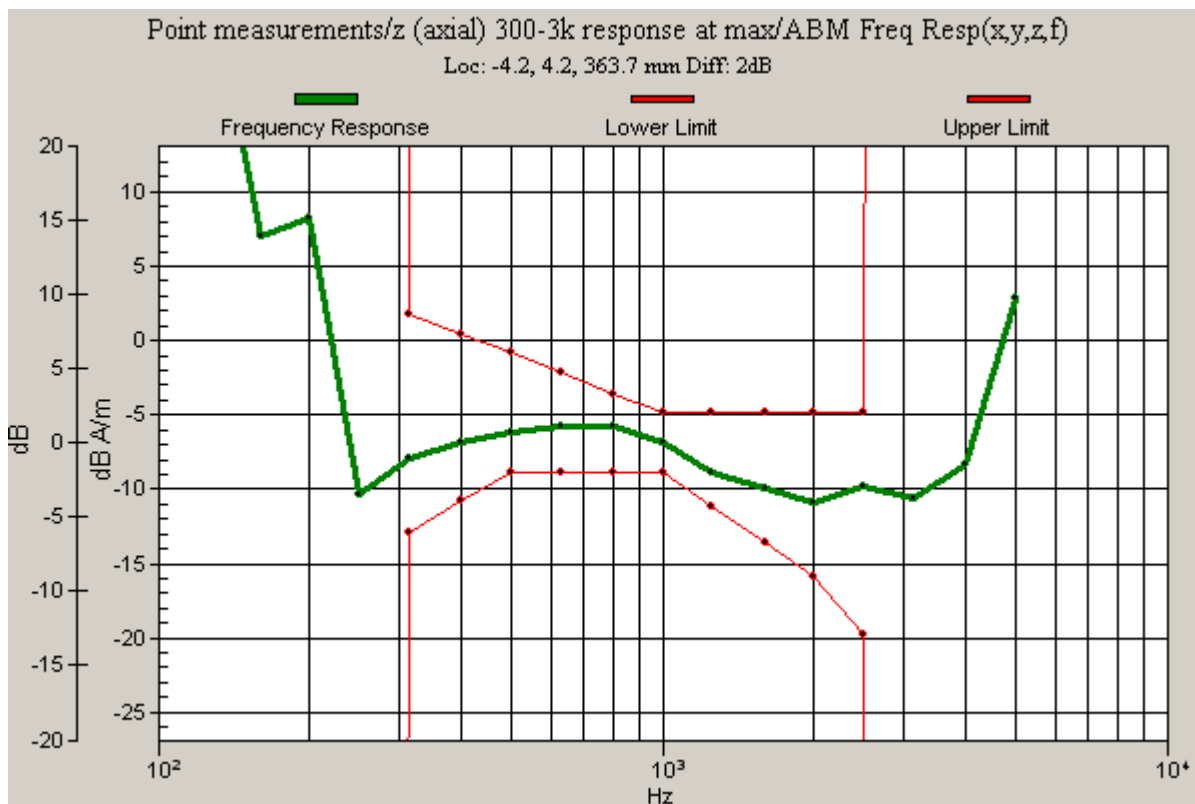
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: -4.2, 4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC43 - SO3 8k Enhanced Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

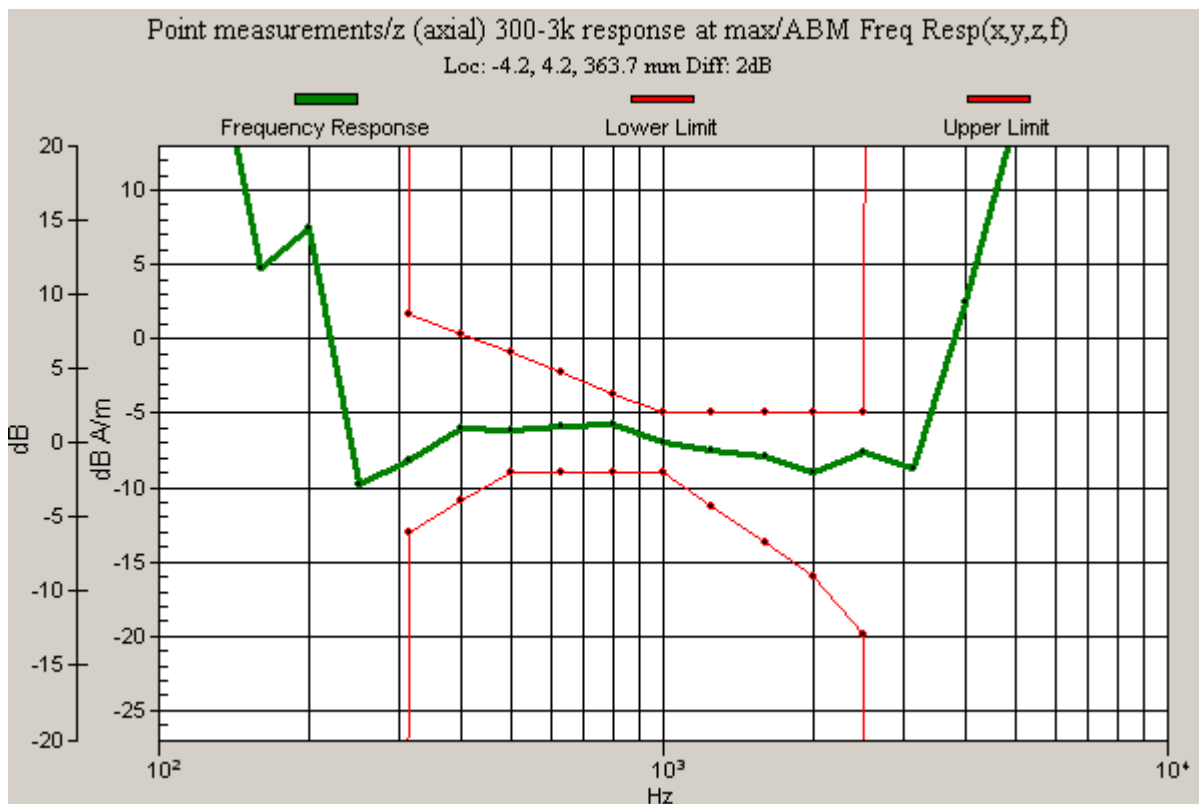
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: -4.2, 4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC54 - SO17 13k Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

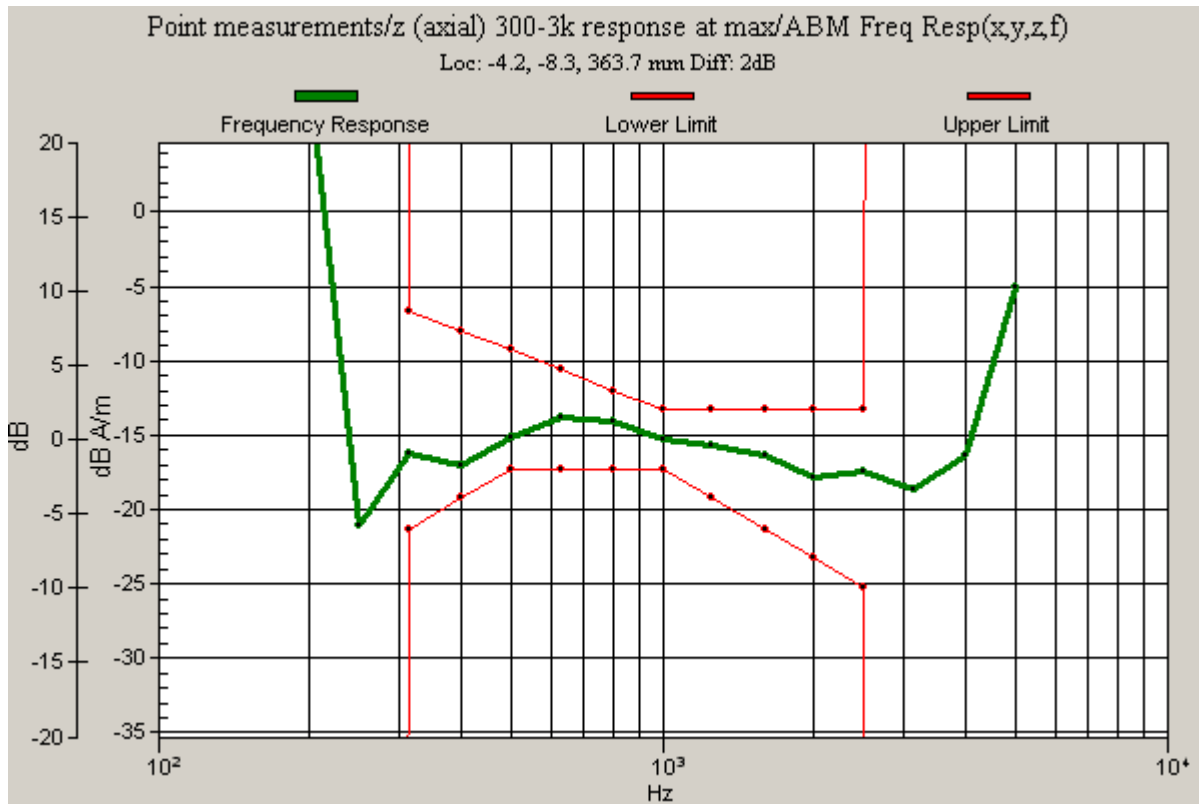
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: -4.2, -8.3, 363.7 mm



Test Laboratory: Compliance Certification Services
File Name: [RC1 - SO3 8k Enhanced Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

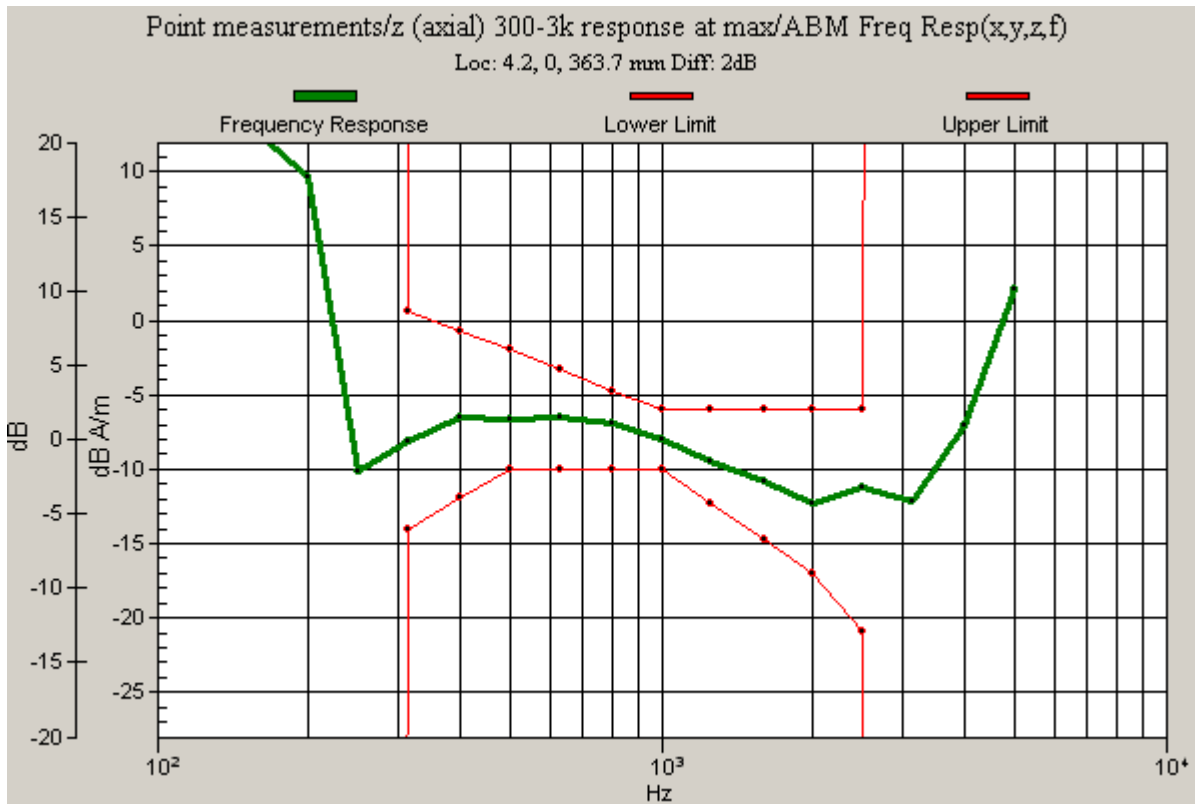
Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: 4.2, 0, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC2 - SO17 13 Low - Ch 25.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1851.25 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

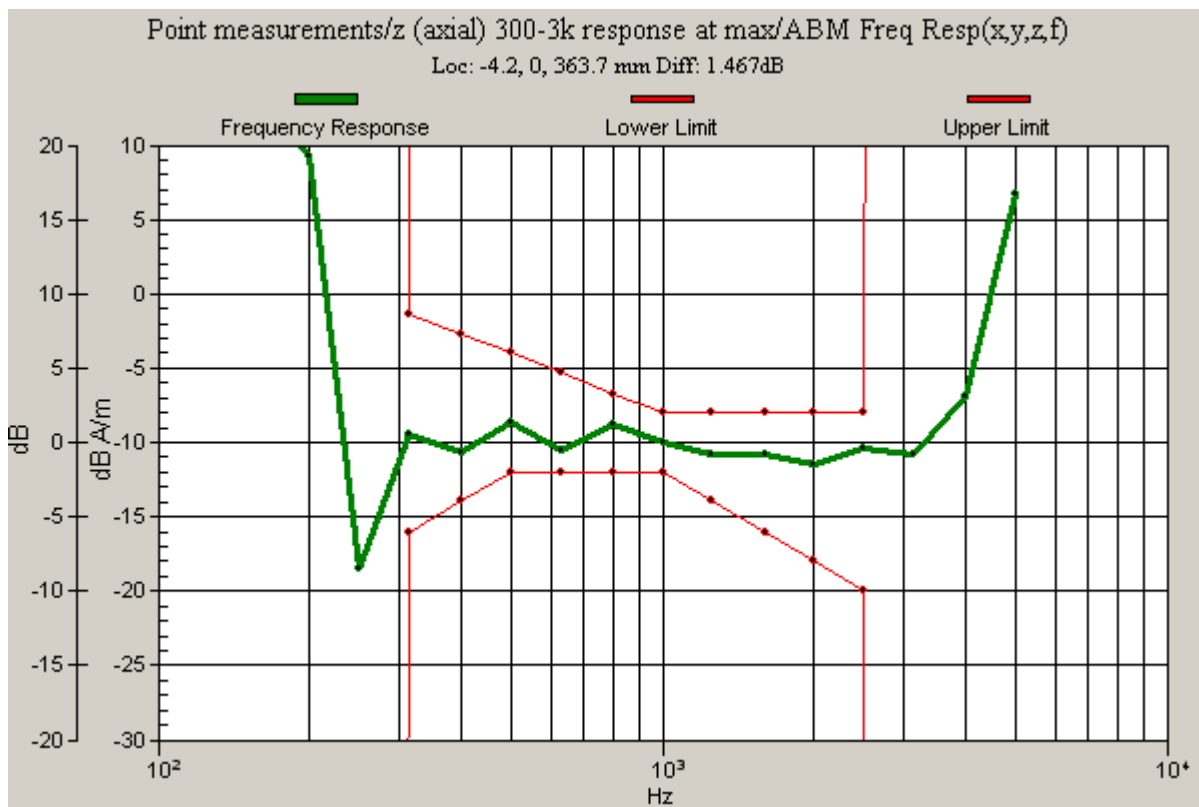
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 1.46717 dB

BWC Factor = 10.8 dB

Location: -4.2, 0, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC2 - SO17 13 Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

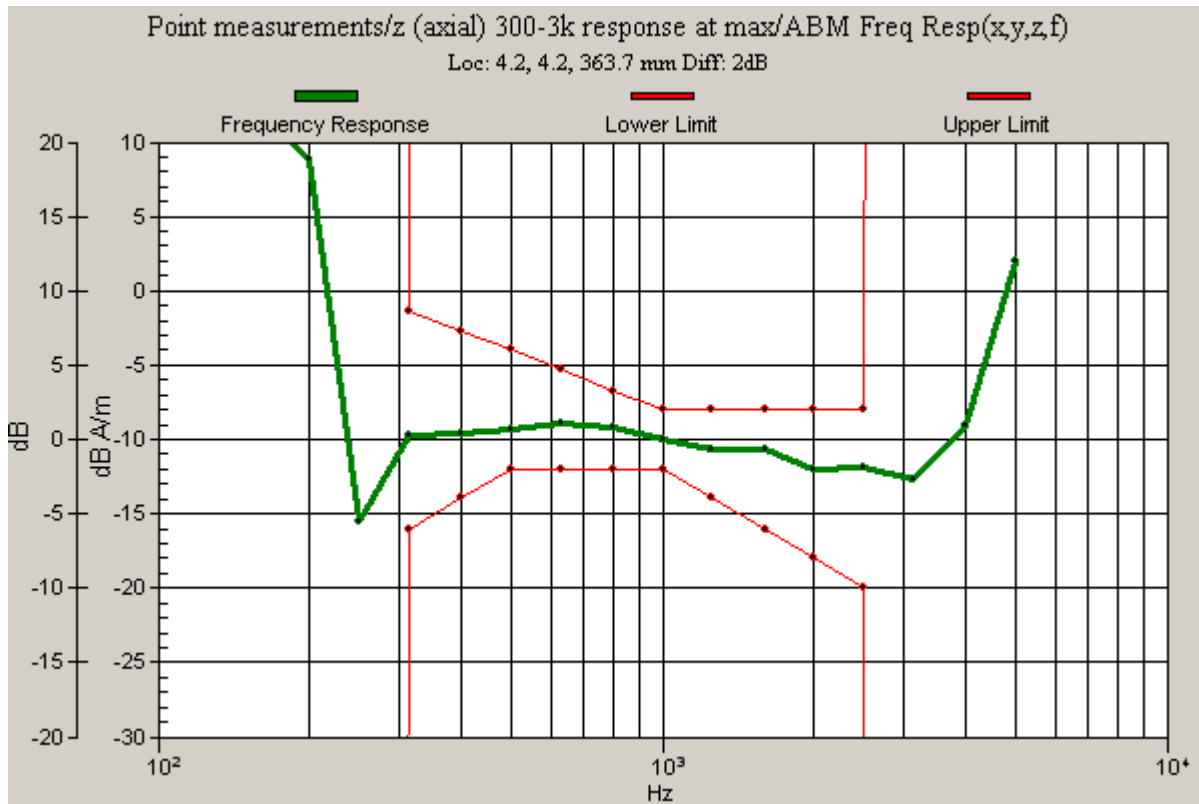
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: 4.2, 4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC2 - SO17 13 Low - Ch 1175.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1908.75 MHz; Duty Cycle: 1:1
 Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
 Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

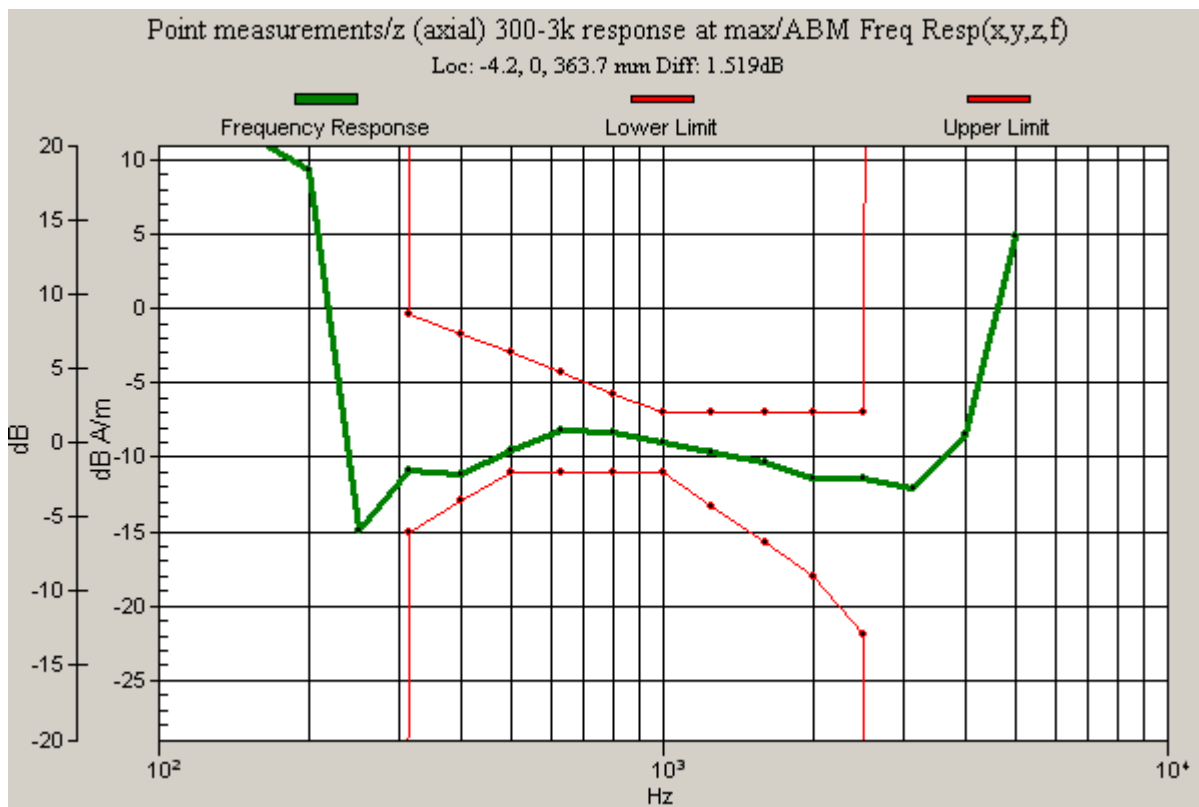
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 1.51927 dB

BWC Factor = 10.9 dB

Location: -4.2, 0, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC3 - SO3 8k Enhanced Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

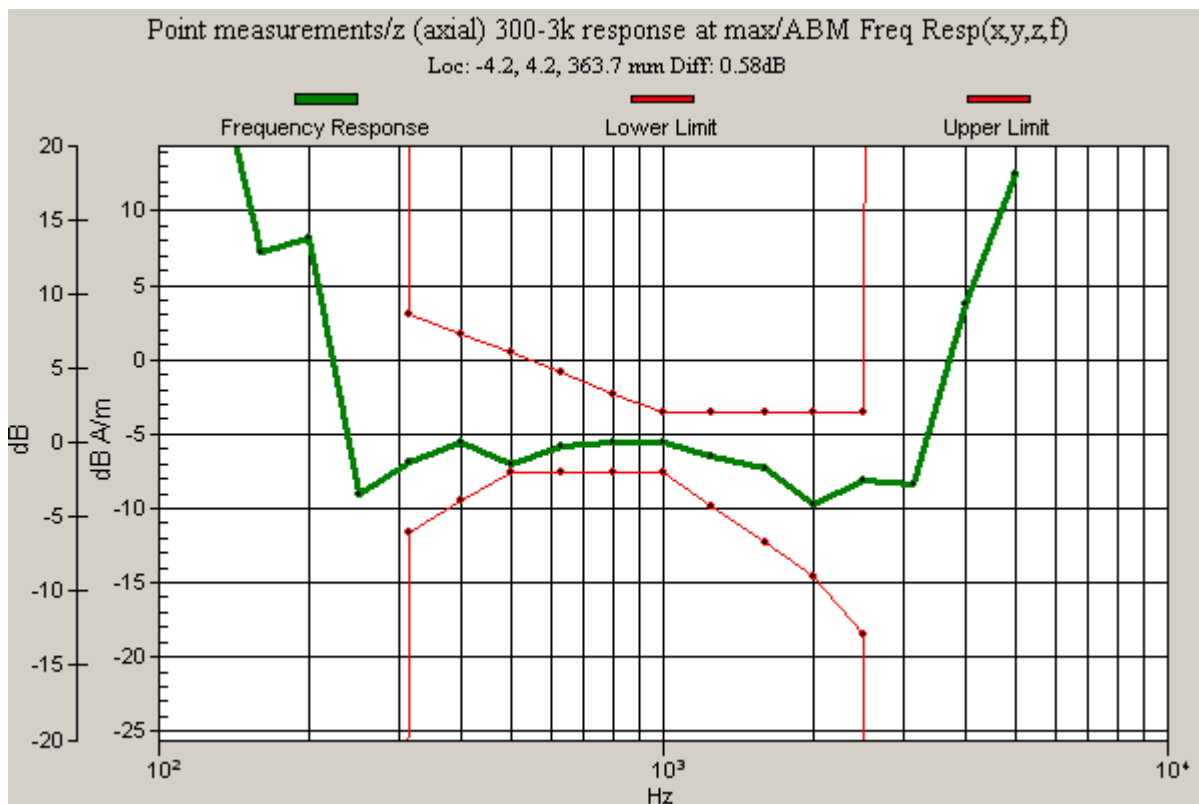
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 0.580227 dB

BWC Factor = 10.8 dB

Location: -4.2, 4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC43 - SO3 8k Enhanced Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

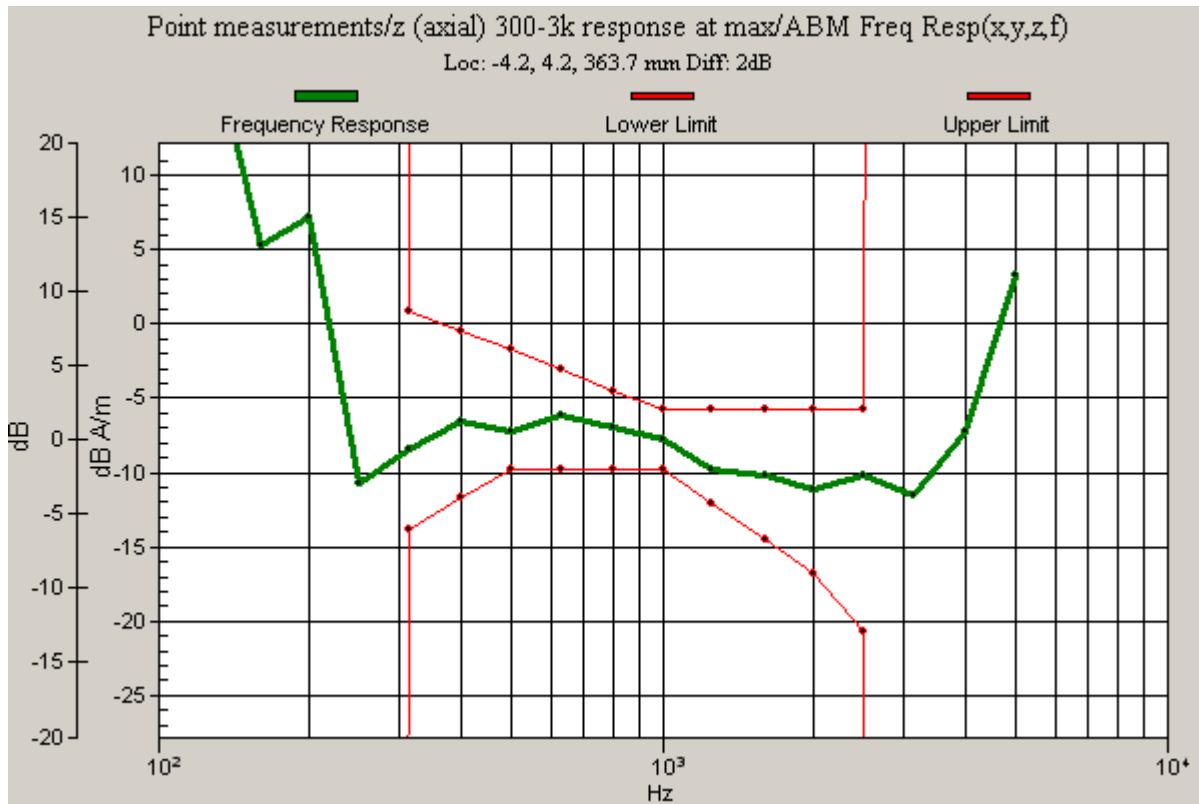
Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 2 dB

BWC Factor = 10.8 dB

Location: -4.2, 4.2, 363.7 mm



Test Laboratory: Compliance Certification Services
 File Name: [RC54 - SO17 13 Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Point measurements/z (axial) 300-3k response at max/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

Diff = 1.69372 dB

BWC Factor = 10.8 dB

Location: -4.2, 4.2, 363.7 mm

